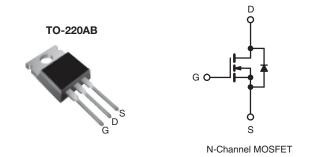


### Power MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	60	60				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V	0.20				
Q <sub>g</sub> (Max.) (nC)	11	11				
Q <sub>gs</sub> (nC)	3.	3.1				
Q <sub>gd</sub> (nC)	5.8	5.8				
Configuration	Sing	Single				



### **FEATURES**

- Dynamic dV/dt Rating
- 175 °C Operating Temperature
- Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC





#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRFZ14PbF		
Lead (Fb)-lifee	SiHFZ14-E3		
SnPb	IRFZ14		
SIFD	SiHFZ14		

ABSOLUTE MAXIMUM RATINGS (Tc	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage <sup>f</sup>			$V_{DS}$	60	V	
Gate-Source Voltage <sup>f</sup>			$V_{GS}$	± 20	7 Y	
Continuous Drain Current	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25  ^{\circ}{\rm C}$ $T_{\rm C} = 100  ^{\circ}{\rm C}$	I <sub>D</sub>	10		
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		7.2	Α	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	40	1	
Linear Derating Factor				0.29	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	47	mJ	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C		$P_{D}$	43	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	4.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	- °C	
Soldering Recommendations (Peak Temperature) for 10 s			300 <sup>d</sup>			
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
				1.1	N · m	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 25 V; starting  $T_J$  = 25 °C, L = 1.47 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 8 A (see fig. 12).
- c.  $I_{SD} \leq 10$  A,  $dI/dt \leq 90$  A/µs,  $V_{DD} \leq V_{DS}, \, T_J \leq 175$  °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62		
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	3.5		

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μA	60	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.063	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	- V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	,	V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
Zoro Cata Valtago Drain Current	1	V <sub>DS</sub> :	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$			25	μA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 48 \text{ V}$	, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C	-	-	250	μΑ
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	$I_D = 6.0 \text{ A}^b$	-	-	0.20	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 25 V, I <sub>D</sub> = 6.0 A <sup>b</sup> 2.4 \$		S			
Dynamic							
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V,		-	300	-	
Output Capacitance	C <sub>oss</sub>	]	$V_{DS} = 25 \text{ V},$	-	160	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	t = 1.	f = 1.0 MHz, see fig. 5		29	-	1
Total Gate Charge	Qg			-	-	11	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_D = 10 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and $13^b$	-	-	3.1	nC
Gate-Drain Charge	$Q_{gd}$		grama ra	-	-	5.8	
Turn-On Delay Time	t <sub>d(on)</sub>			-	10	-	
Rise Time	t <sub>r</sub>		$= 30 \text{ V}, I_D = 10 \text{ A},$	-	50	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	13	-	ns
Fall Time	t <sub>f</sub>			-	7		
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from		-	4.5	-	
Internal Source Inductance	L <sub>S</sub>	die contact	center of	-	7.5	-	- nH
Drain-Source Body Diode Characteristic	s			•	•	•	
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET sym showing the	MOSFET symbol showing the		-	10	A
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral revers p - n junction	· /	-	-	40	
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C	$C$ , $I_S = 10 \text{ A}$ , $V_{GS} = 0 \text{ V}^b$	-	-	1.6	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T 25 °C 1	- 10 A dl/dt - 100 A/:-ah	-	70	140	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	] IJ=25 C, IF	= 10 A, $dI/dt = 100 A/\mu s^b$	-	0.20	0.40	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	rn-on time is negligible (turn	-on is dor	minated b	y L <sub>S</sub> and	L <sub>D</sub> )

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$





### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

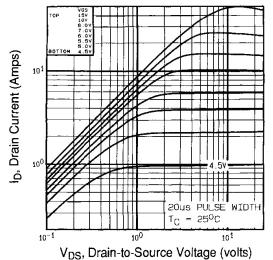
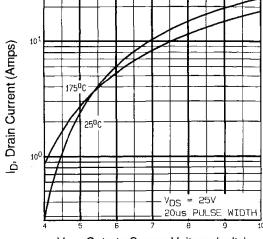


Fig. 1 - Typical Output Characteristics,  $T_C = 25$  °C



V<sub>GS</sub>, Gate-to-Source Voltage (volts)



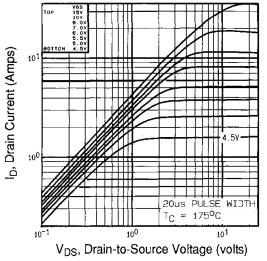


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 175 °C

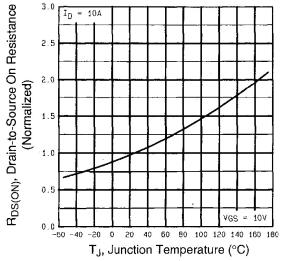
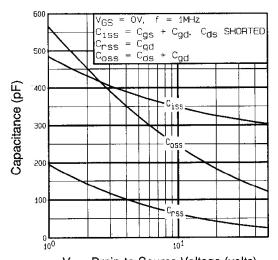


Fig. 4 - Normalized On-Resistance vs. Temperature





V<sub>DS</sub>, Drain-to-Source Voltage (volts)
Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

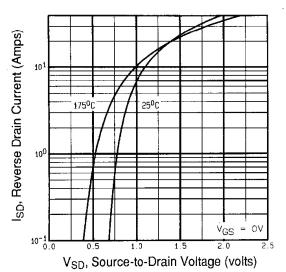


Fig. 7 - Typical Source-Drain Diode Forward Voltage

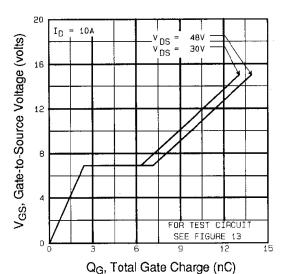


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

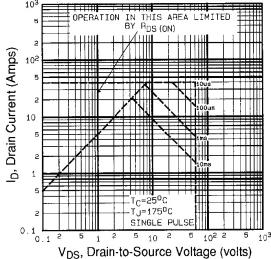


Fig. 8 - Maximum Safe Operating Area





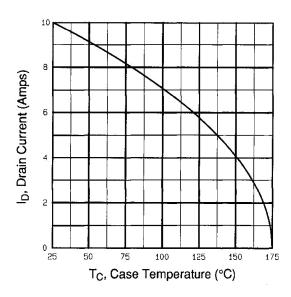


Fig. 9 - Maximum Drain Current vs. Case Temperature

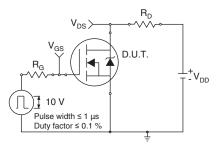


Fig. 10a - Switching Time Test Circuit

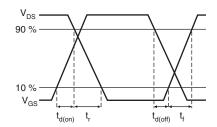


Fig. 10b - Switching Time Waveforms

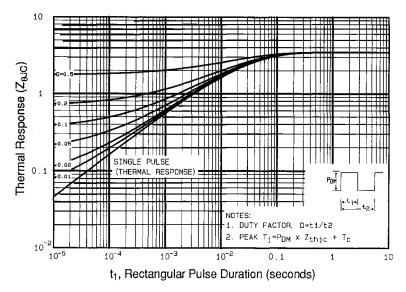


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

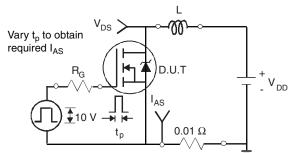


Fig. 12a - Unclamped Inductive Test Circuit

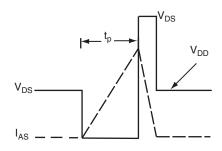


Fig. 12b - Unclamped Inductive Waveforms



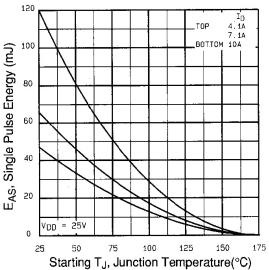


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

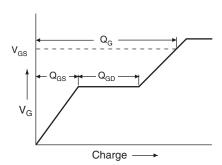


Fig. 13a - Basic Gate Charge Waveform

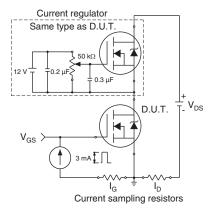
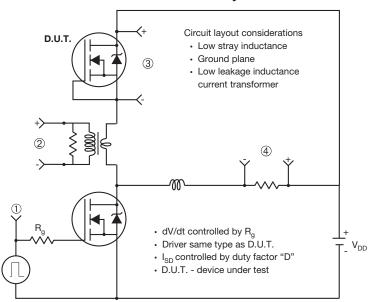


Fig. 13b - Gate Charge Test Circuit





### Peak Diode Recovery dV/dt Test Circuit



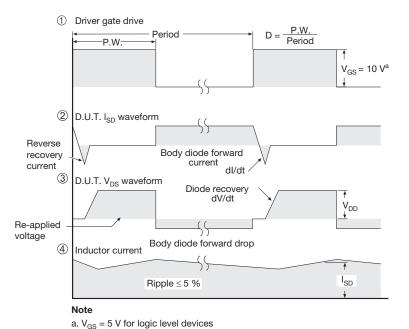


Fig. 14 - For N-Channel

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# TO-220-1



DIM.	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	

#### Note

 $\bullet$   $M^{\star}=0.052$  inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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